

L Number	Hits	Search Text	DB	Time stamp
-	397	(118/733).CCLS.	USPAT; US-PGPUB	2003/04/10 10:38
-	1240	(118/719).CCLS.	USPAT; US-PGPUB	2003/04/08 12:53
-	140	((118/733).CCLS.) and ((118/719).CCLS.)	USPAT; US-PGPUB	2003/04/08 12:56
-	1978	((156/345.31) or (156/345.32) or (414/939) or (414/935) or (118/719)).CCLS.	USPAT; US-PGPUB	2003/04/08 12:56
-	0	((118/733).CCLS.) and 4.	USPAT; US-PGPUB	2003/04/08 12:56
-	154	((118/733).CCLS.) and (((156/345.31) or (156/345.32) or (414/939) or (414/935) or (118/719)).CCLS.)	USPAT; US-PGPUB	2003/04/08 14:01
-	13	4622918.URPN.	USPAT	2003/04/08 13:12
-	10	("3192845" "3588176" "3731823" "3734567" "3976330" "3999806" "4278366" "4403002" "4480777" "4544446").PN.	USPAT	2003/04/08 13:15
-	3	steel with isolat\$3 with chamber with vacuum	EPO; JPO; DERWENT	2003/04/08 14:03
-	13	steel with isolat\$3 with chamber with vacuum	USPAT; US-PGPUB	2003/04/08 14:03
-	3	(steel with isolat\$3) same (chamber with vacuum)	EPO; JPO; DERWENT	2003/04/08 14:04
-	30	(steel with isolat\$3) same (chamber with vacuum)	USPAT; US-PGPUB	2003/04/08 14:09
-	405	(steel with (thermal\$3 heat temperature)) same (chamber with vacuum)	USPAT; US-PGPUB	2003/04/08 14:11
-	345	(steel with (seal\$3 separat\$3)) same (chamber with vacuum)	USPAT; US-PGPUB	2003/04/08 15:09
-	55	(steel with (thermal\$3 heat temperature)) same (chamber with vacuum) same (transfer\$3 transport\$3)	USPAT; US-PGPUB	2003/04/08 15:02
-	15	(steel with (thermal\$3 heat temperature)) same (chamber with vacuum) same (transfer\$3 transport\$3) same (semiconductor substrate wafer)	USPAT; US-PGPUB	2003/04/08 15:05
-	8	(steel with (seal\$3 separat\$3)) same (chamber with vacuum) same (substrate wafer semiconductor)	EPO; JPO; DERWENT	2003/04/08 15:12
-	49	(steel with (seal\$3 separat\$3)) same (chamber with vacuum) same (substrate wafer semiconductor)	USPAT; US-PGPUB	2003/04/08 15:38
-	22	5121705.URPN.	USPAT	2003/04/08 15:35
-	482	(thermal\$3) with (isolat\$3 separat\$3 seal\$3 close\$3 prevent\$3) with (steel) with (interface face plate surface)	USPAT; US-PGPUB	2003/04/08 15:41
-	34	((thermal\$3) with (isolat\$3 separat\$3 seal\$3 close\$3 prevent\$3) with (steel) with (interface face plate surface)) same chamber	USPAT; US-PGPUB	2003/04/08 15:53
-	14	((thermal\$3) with (isolat\$3 separat\$3 seal\$3 close\$3 prevent\$3) with (steel) with (interface face plate surface)) same chamber	EPO; JPO; DERWENT	2003/04/08 15:59
-	612	((isolat\$3 separat\$3 seal\$3 close\$3 prevent\$3) with (steel) with (interface face plate surface)) same chamber	EPO; JPO; DERWENT	2003/04/08 16:01
-	717	((isolat\$3 separat\$3 seal\$3 close\$3 prevent\$3) with (steel) with (interface face plate surface)) and (chamber apparatus) and (heat\$3 temperature thermal\$3)	EPO; JPO; DERWENT	2003/04/08 16:05
-	345	((isolat\$3 separat\$3 seal\$3 close\$3 prevent\$3) with (steel) with (interface face plate surface)) same (chamber apparatus) same (heat\$3 temperature thermal\$3)	EPO; JPO; DERWENT	2003/04/08 16:06

-	120	((isolat\$3 separat\$3 seal\$3 close\$3 prevent\$3) with (steel) with (interface face plate surface)) same (chamber apparatus) same (heat\$3 temperature thermal\$3) same vacuum	USPAT; US-PGPUB	2003/04/08 16:10
-	39	((isolat\$3 separat\$3 seal\$3 close\$3 prevent\$3) with (steel) with (interface face plate surface)) same (chamber apparatus) same (heat\$3 temperature thermal\$3) same vacuum	EPO; JPO; DERWENT	2003/04/08 16:15
-	848	(34/242).CCLS.	USPAT; US-PGPUB	2003/04/08 16:27
-	26	((34/242).CCLS.) and ((thermal\$3 heat temperature) with steel)	USPAT; US-PGPUB	2003/04/08 16:20
-	67	(34/209).CCLS.	USPAT; US-PGPUB	2003/04/08 16:40
-	1067	(34/92).CCLS.	USPAT; US-PGPUB	2003/04/08 16:40
-	0	(423/242).CCLS.	USPAT; US-PGPUB	2003/04/08 16:40
-	284	(432/242).CCLS.	USPAT; US-PGPUB	2003/04/08 16:57
-	36	((432/242).CCLS.) and (stainless with steel)	USPAT; US-PGPUB	2003/04/08 16:41
-	48	((432/242).CCLS.) and (vacuum)	USPAT; US-PGPUB	2003/04/08 16:41
-	20	((432/242).CCLS.) and (stainless with steel)) and (((432/242).CCLS.) and (vacuum))	USPAT; US-PGPUB	2003/04/08 16:58
-	3	3759662.URPN.	USPAT	2003/04/08 16:44
-	264	((432/242).CCLS.) not (((432/242).CCLS.) and (stainless with steel)) and (((432/242).CCLS.) and (vacuum)))	USPAT; US-PGPUB	2003/04/08 17:33
-	16	((432/242).CCLS.) and (stainless with steel)) not (((432/242).CCLS.) and (stainless with steel)) and (((432/242).CCLS.) and (vacuum)))	USPAT; US-PGPUB	2003/04/08 17:22
-	248	((432/242).CCLS.) not (((432/242).CCLS.) and (stainless with steel)) and (((432/242).CCLS.) and (vacuum)))	USPAT; US-PGPUB	2003/04/08 17:32
-	0	((432/242).CCLS.) and cluster	USPAT; US-PGPUB	2003/04/08 17:33
-	0	((432/242).CCLS.) and 118/719.ccls.	USPAT; US-PGPUB	2003/04/08 17:34
-	0	((432/242).CCLS.) and (156/345.31 156/345.32)	USPAT; US-PGPUB	2003/04/09 15:33
-	27	((432/242).CCLS.) and 414/\$.ccls.	USPAT; US-PGPUB	2003/04/08 17:34
-	1	("4997364").PN.	USPAT; US-PGPUB	2003/04/09 14:40
-	10	4997364.URPN.	USPAT	2003/04/09 14:40
-	1	"5512320".PN.	USPAT	2003/04/09 15:19
-	0	6338626.pn. and steel	USPAT; US-PGPUB	2003/04/09 15:21
-	1	6338626.pn.	USPAT; US-PGPUB	2003/04/09 15:21
-	42	(118/719.CCLS. 156/345.31.ccls. 156/345.32.ccls.) and ((heat\$3 temperature heat) with shield\$3 with chamber)	USPAT; US-PGPUB	2003/04/09 17:14
-	2	"62147726"	JPO; DERWENT	2003/04/09 16:39
-	1	("5601686").PN.	USPAT; US-PGPUB	2003/04/09 16:46
-	4	5601686.URPN.	USPAT	2003/04/09 16:40
-	1	("5562800").PN.	USPAT; US-PGPUB	2003/04/09 16:51
-	6	5562800.URPN.	USPAT	2003/04/09 16:47



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